SCOPE:

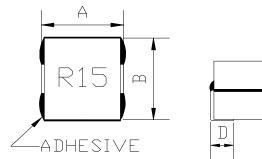
This specification applies to the Pb Free high current type SMD inductors for MSI-700705-SERIES

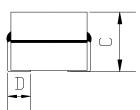
PRODUCT INDENTIFICATION

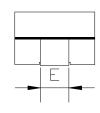
MSI- 700705- R15 M

- (1)
- (2)
- 3 4
- ① Product Code
- 2 Dimensions Code
- **3 Inductance Code**
- **4** Tolerance Code

(1) SHAPES AND DIMENSIONS







A: 7.0 Max. mm
B: 7.0 Max. mm
C: 4.96 Max. mm
D: 1.52 Typ. mm
E: 2.49 Typ. mm

(2) ELECTRICAL SPECIFICATIONS SEE TABLE 1

TEST INSTRUMENTS

L: HP 4284A PRECISION LCR METER (or equivalent)

RDC: CHROMA MODEL 16502 MILLIOHMMETER (or equivalent)

IDC1: CH3302/G LCR METER

CH1320, CH1320S BIAS CURRENT SOURCE(or equivalent)

(3) CHARACTERISTICS

- (3)-1 Ambient temperature +60°C Max.
- (3)-2 Operate temperature range $-40^{\circ}\text{C} \sim +125^{\circ}\text{C}$ (Including self temp. rise)
- (3)-3 Storage temperature range -40° C $\sim +125^{\circ}$ C



TABLE 1

MAGLAYERS	Inductance	Percent	Test	Resistance	Rated DC Current		Morking	
PT/NO.	L(µH)	Tolerance	Frequency	RDC(mΩ)	IDC1(A)	IDC2(A)	Marking	
MSI-700705-72N	0.072	M,N	100kHz/0.1V	0.32 ±9.4%	58	31	72N	
MSI-700705-R10□	0.10	M,N	100kHz/0.1V	0.32 ±9.4%	46	31	R10	
MSI-700705-R15□	0.15	M,N	100kHz/0.1V	0.32 ±9.4%	30	31	R15	

※ ☐ specify the inductance tolerance,M(±20%),N(±30%)

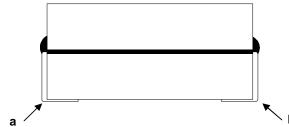
% IDC1 : Based on inductance change (\triangle L/Lo : drop 20% TYP.)@ ambient temp. 25 $^{\circ}$ C

IDC2: Based on temperature rise (△T: 40°C TYP.)

Rated DC Current: The less value which is IDC1 or IDC2.

RDC TEST POINT

The nominal DCR is measured from point a'' to point b''.



(4) RELIABILITY TEST METHOD

MECHANICAL

TEST ITEM	SPECIFICATION	TEST DETAILS				
Substrate bending	∆L/Lo≦±5%	The sample shall be soldered onto the printed circuit board				
		in figure 1 and a load applied unitil the figure in the arrow				
	There shall be	direction is made approximately 3mm.(keep time 30 seconds)				
	no mechanical	PCB dimension shall the page 7/9				
	damage or elec-	F(Pressurization)				
	trical damege.	Л				
		R5 45±2 45±2 10 20 R340				
		PRESSURE ROD figure-1				
Vibration	∆L/Lo≦±5%	The sample shall be soldered onto the printed circuit board				
		and when a vibration having an amplitude of 1.52mm				
	There shall be	and a frequency of from 10 to 55Hz/1 minute repeated should				
	no mechanical	be applied to the 3 directions (X,Y,Z) for 2 hours each.				
	damage.	(A total of 6 hours)				
Solderability	New solder	Flux (rosin, isopropyl alcohol{JIS-K-1522}) shall be coated				
,	More than 90%	over the whole of the sample before hard, the sample shall				
		then be preheated for about 2 minutes in a temperature of				
		130∼150°C and after it has been immersed to a depth 0.5mm				
		below for 3±0.2 seconds fully in molten solder M705 with				
		a temperature of 245±5℃.				
		More than 90% of the electrode sections shall be couered				
		with new solder smoothly when the sample is taken out of				
		the solder bath.				

MECHANICAL

TEST ITEM	SPECIFICATION					
TEST ITEM Resistance to Soldering heat (reflow soldering)	There shall be no damage or problems.	Temperature profile of reflow soldering soldering (Peak temperature 260±3°C 10 sec 250 200 Pre-heating Pre-heating				
		Slow cooling (Stored at room temperature) 2 min 10 2 min or mere The specimen shall be passed through the reflow oven with the				
		condition shown in the above profile for 1 time. The specimen shall be stored at standard atmospheric conditions for 1 hour, after which the measurement shall be made.				

ELECTRICAL

TEST ITEM	SPECIFICATION	TEST DETAILS
Temperature	∆L/L20 ℃ ≦±10 %	The test shall be performed after the sample has stabilized in
characteristics	0~2000 ppm/℃	an ambient temperature of -20 to +85℃,and the value
		calculated based on the value applicable in a normal
		temperature and narmal humidity shall be △L/L20°C ≦±10%.

ENVIROMENT CHARACTERISTICS

TEST ITEM				SPECIFICATION			
High temperature	∆L/Lo≦±5%	The samp	The sample shall be left for 96±4 hours in an atmospere with				
storage		a tempera	a temperature of 85±2 $^{\circ}$ C and a normal humidity.				
	There shall be	Upon completion of the measurement shall be made after the					
	no mechanical	sample has been left in a normal temperature and normal					
	damage.	humidity for 1 hour.					
Low temperature	∆L/Lo≦±5%	The samp	The sample shall be left for 96±4 hours in an atmosphere with				
storage		a temperature of -25±3℃.					
	There shall be	Upon completion of the test, the measurement shall be made					
	no mechanical	after the s	after the sample has been left in a normal temperature and				
	damage.	normal hu	normal humidity for 1 hour.				
Change of	∆L/Lo≦±5%	The samp	The sample shall be subject to 5 continuos cycles, such as shown				
temperature		in the table 2 below and then it shall be subjected to standard				I	
	There shall be	atmosphe	atmospheric conditions for 1 hour, after which measurement				
no other dama- shall be made.							
	ge of problems						
			table 2				
				Temperature	Duration		
			1	−25±3 ℃	30 min.		
				(Themostat No.1)			
			2	Standard	No.1→No.2		
				atmospheric			
			3	85±2 ℃	30 min.		
				(Themostat No.2)			
			4	Standard	No.2→No.1		
				atmospheric			
Moisture storage	∆L/Lo≦±5%	The sample shall be left for 96±4 hours in a temperature of					
_		40±2℃ and a humidity(RH) of 90∼95%.					
	There shall be	Upon completion of the test, the measurement shall be made					
	no mechanical	after the sample has been left in a normal temperature and					
	damage.	normal humidity more than 1 hour.					
Test conditions :	l	1					



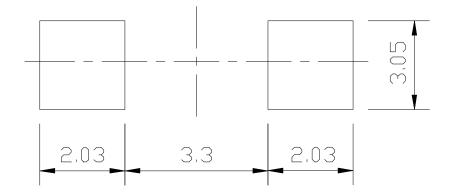
The sample shall be reflow soldered onto the printed circuit board in every test.

(5) LAND DIMENSION (Ref.)

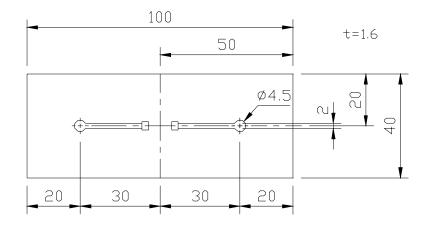
PCB: GLASS EPOXY t=1.6mm

(5)-1 LAND PATTERN DIMENSIONS(mm)

(STANDARD PATTERN) Unit:mm



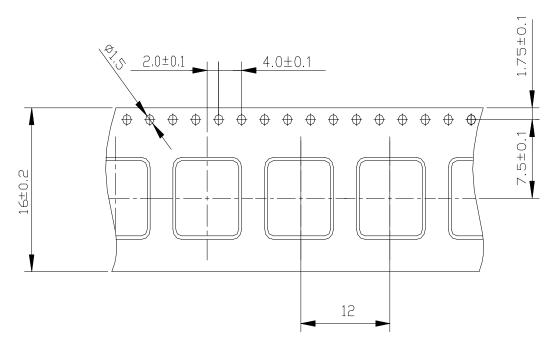
(5)-2 SUBSTRATE BENDING TEST BENDING TEST BOARD





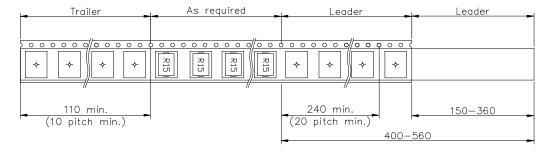
(6) PACKAGING

(6)-1 CARRIER TAPE DIMENSIONS (mm)

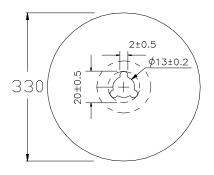


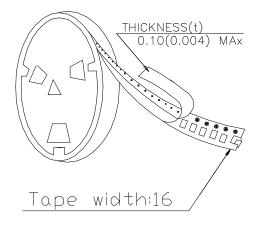
(6)-2 TAPING DIMENSIONS (mm)





(6)-3 REEL DIMENSIONS (mm)





(6)-4 QUANTITY

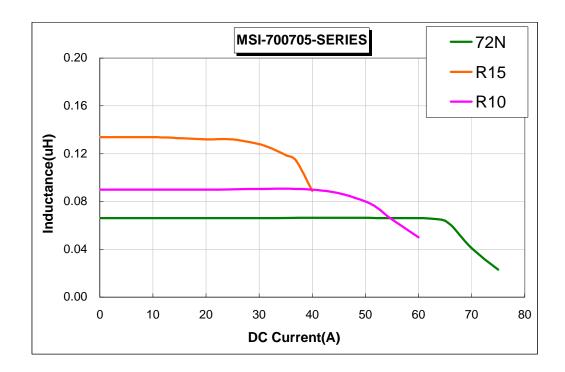
1000pcs/Reel

The products are packaged so that no damage will be sustained.



TYPICAL ELECTRICAL CHARACTERISTICS

INDUCTANCE vs. DC CURRENT@100kHz/0.1V Ambient Temperature : 25℃



Temperature Rise vs. DC Current

